

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: LENNY LOW ET AL.

Date: December 16, 2002

Serial Ño. 09/822,073

Group Art Unit: 3743

Filed: March 30, 2001

For: HEAT TRANSFER OF A REMOTE HEAT:

SOURCE USING A LOOP HEAT PIPE

Examiner: Christopher. M. Atkinson

AMENDMENT

Commissioner of Patents and Trademarks Washington, D. C. 20231

Sir:

In response to the Office Action mailed June 18, 2002, please amend the aboveidentified patent application as follows.

RECEIVED

IN THE CLAIMS

Please amend the following Claims to read as indicted

JAN 0 3 2003 TECHNOLOGY CENTER R3700

1. A heat transfer system comprising: a spacecraft comprising a heat dissipating system;

a remotely-located heat source disposed on the spacecraft at a location that is remote from the heat dissipating system and which is not located on a heat pipe panel; and

a loop heat pipe thermally coupled between the remotely-located heat source and the heat dissipating system for coupling heat generated by the heat source to the heat dissipating system.

3. A spacecraft comprising:

a heat dissipating system for radiating heat into space;

a remotely-located heat source disposed at a location that is remote from the heat dissipating system and which is not located on a heat pipe panel; and

a loop heat pipe thermally coupled between the remotely-located heat source and the heat dissipating system for coupling heat generated by the remotely-located heat source to the heat dissipating system.

5

5. A heat dissipation method for use on a spacecraft comprising the steps of: disposing a remotely-located heat source on a spacecraft at a location that is remote from a heat dissipating system and which is not located on a heat pipe panel;

thermally coupling a loop heat pipe between the remotely-located heat source and the heat dissipating system; and

coupling heat generated by the remotely-located heat source to the heat dissipating system by way of the loop heat pipe.